

**QWIP FPA
in
STRV-1d MISSION**

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James T. Kenny and Harold R. Pollock

Jet Propulsion Laboratory
California Institute of Technology
Pasadena, California

A decorative graphic is located at the top center of the slide. It is a horizontal, elongated, teardrop-shaped object with a textured, metallic appearance. It has a dark horizontal line running through its center.

OBJECTIVES

- Demonstrate and assess QWIP FPA uniformity, stability, and repeatability in a space environment
 - Spatial non-uniformity
 - Photo current and dark current
 - Instability
 - Mean photo current, dark current over experiment cycle
 - Non-repeatability
 - Mean dark current
 - Mean responsivity
- Demonstrate QWIP radiation tolerance using QWIP diodes by tracking changes in responsivity.



WHY QWIP

- QWIP complements and extends HgCdTe sensor technology.
- QWIP enables fabrication of large arrays for strategic surveillance.
- QWIP provides long term stability of Responsivity.
- QWIP operates at wavelength longer than 15μ at 40°K .



MISSION

- Primary Mission requirements were:
 - minimum of one year in-space operation, and
 - high proton and electron radiation exposure.
- STRV-1 Mission launches to a geosynchronous transfer orbit (GTO)
 - 620 km by 36000 km at 7.5 degree inclination.
 - provides four transitions through proton and electron belts per orbit.
 - One year mission with potential for extension..

A decorative graphic consisting of a horizontal line with a shaded, oval-like shape at its right end, positioned above the title.

DEVELOPMENT GUIDELINES

- Document design, test and operational requirements.
 - Mil-Std 1540 “Test Requirements for Space Vehicles”
 - “Protoflight” requirements tailored to QWIP mission.
 - DOD-Hdbk-343 “Design, Construction, and Testing Requirements for One of a Kind Space Equipment”
 - Class B requirements tailored to QWIP Mission.
 - Mil-Std-1541A “Electromagnetic Compatibility Requirements for Space Systems”
 - Interfaces negotiated and documented with Spacecraft contractor.
 - Interface Control Document for mechanical, thermal, environmental, power, and electrical interfaces.
 - Software Interface Control Document for spacecraft commanding, data format, and data handling.
- Design and Test Requirements
 - 60 requirements allocated in ICD by spacecraft.
 - 22 requirements derived at JPL.

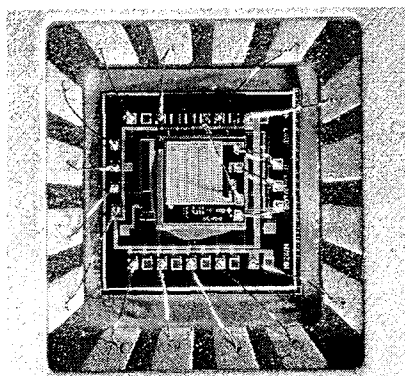
EMI AND RADIATION DESIGN

- EMI Design

- Radiated and conducted emissions and susceptibility.
- Radiated susceptibility to 40 V/m fields at 2269.5 and 2288.5 MHz.

- EMI Test

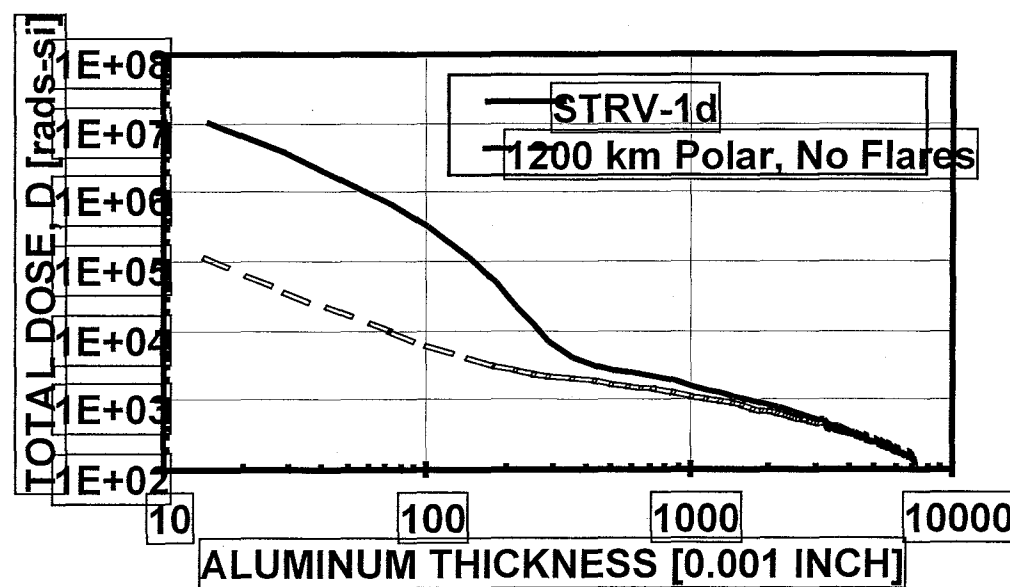
- Measured radiated and conducted emissions during operation.
- Radiated hardware during operation.



Mother chip is 1.8 mm x 2.2 mm and RADFET is about 1mm x 1 mm.

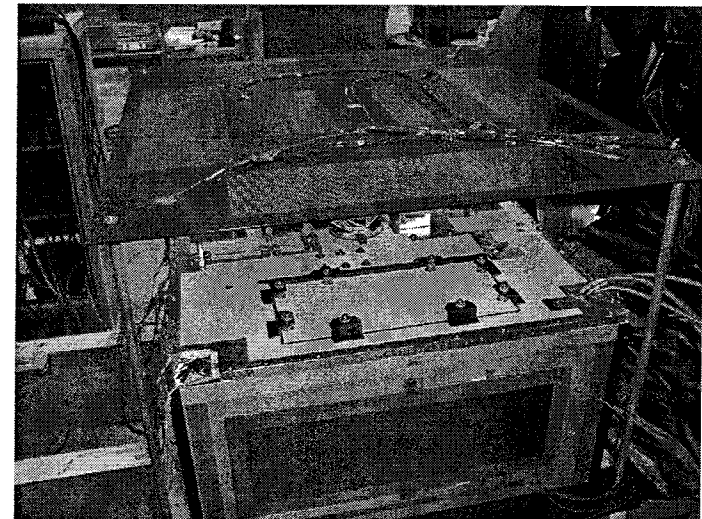
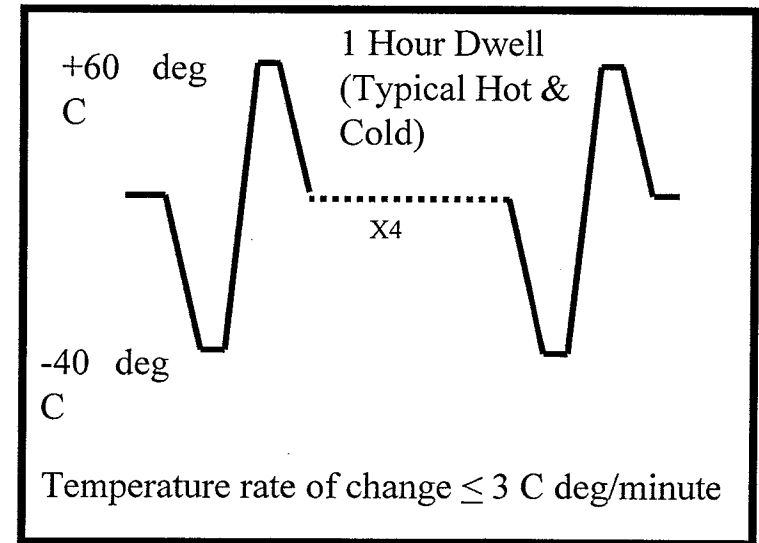
- Radiation Design

- Electronic parts radiation tolerant to 50 Krads or greater.
- Support electronics shielded.
- Data storage in DRAM used triple storage and majority vote.



THERMAL DESIGN AND TEST

- Thermal Design
 - -40°C and $+60^{\circ}\text{C}$ (non-operating or survival limits).
 - -30°C and $+50^{\circ}\text{C}$ (operating limits).
- Thermal Test
 - Completed four temperature cycles in GN2 chamber after fixes validated.
 - Hot and cold starts, and successful operations at hot, cold and ambient temperature verified.
- Thermal-Balance
 - Validated JPL thermal model for flight predicts



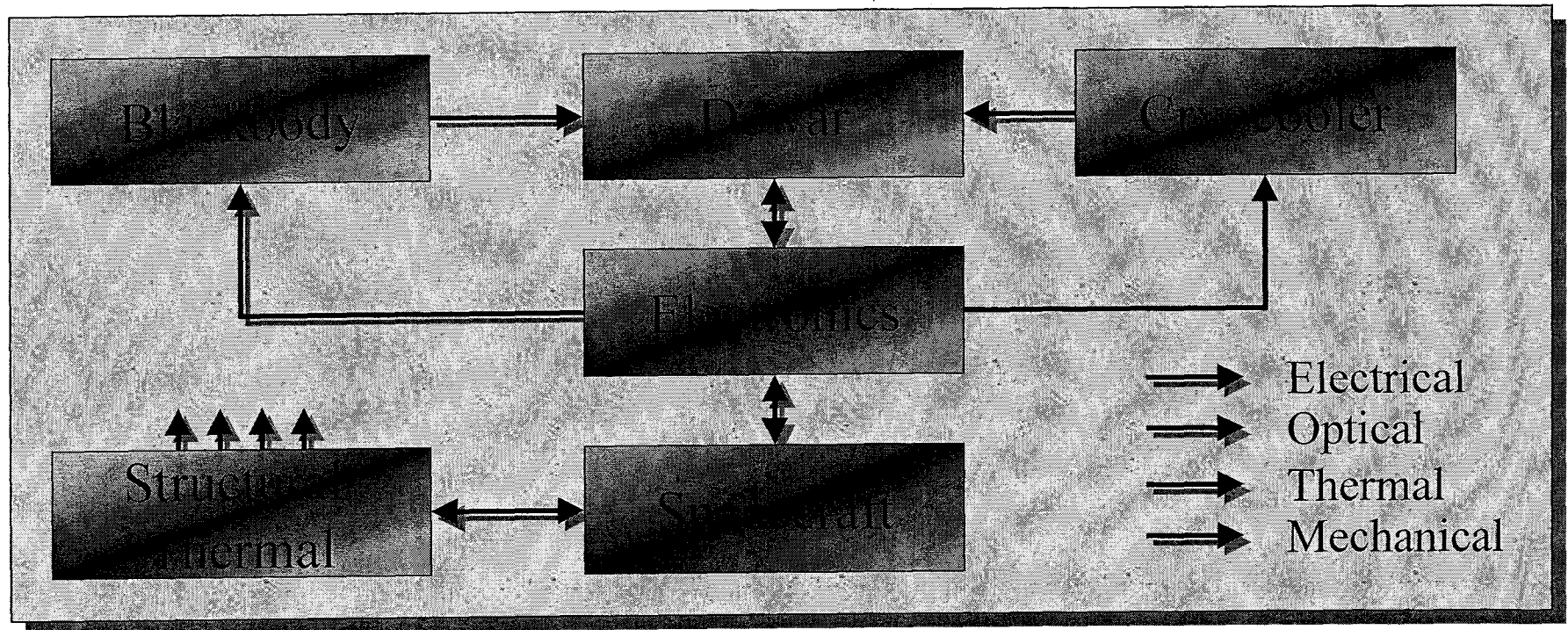
DYNAMIC DESIGN AND TEST

- Dynamic Design
 - Random vibration spectrum developed from spacecraft test response data.
 - Acoustic spectrum derived from Airane 5 Handbook.
- Dynamic Test
 - Electronics Chassis subjected to random vibration only.
 - IDA mounted to MFS Panel subjected to acoustic and random vibration.
 - Random vib-ed in 3-axes, 60 seconds/axis



EXPERIMENT ARCHITECTURE


- The QWIP Experiment has five major subsystems
 - Integrated Dewar Assembly
 - Blackbody Assembly
 - Cryocooler Assembly
 - Structural/Thermal Control
 - Electronics Assembly





INTEGRATED DEWAR AND BLACKBODY

- Dewar
 - Hermetically sealed dewar (minimizes contamination)
 - Cold shield (minimizes non-blackbody flux on FPA)
- Focal Plane
 - Peak response 11.0 ± 0.2 microns
 - Operating Temperature 55 Kelvin
 - Array Format 128 x 128
 - NE Δ T @ 380 K blackbody 1.0 K
 - Integration Time 3.8 milliseconds
 - Integration Time Range 0.2 to 25.0 milliseconds (in steps of 0.2)
- Blackbody
 - Temperature Range ≤ 400 K
 - Temperature Stability ± 0.1 K over 10 minutes
 - Temperature Repeatability ± 0.2 K from cycle to cycle
 - Emissivity Stability ± 0.5 % over its life

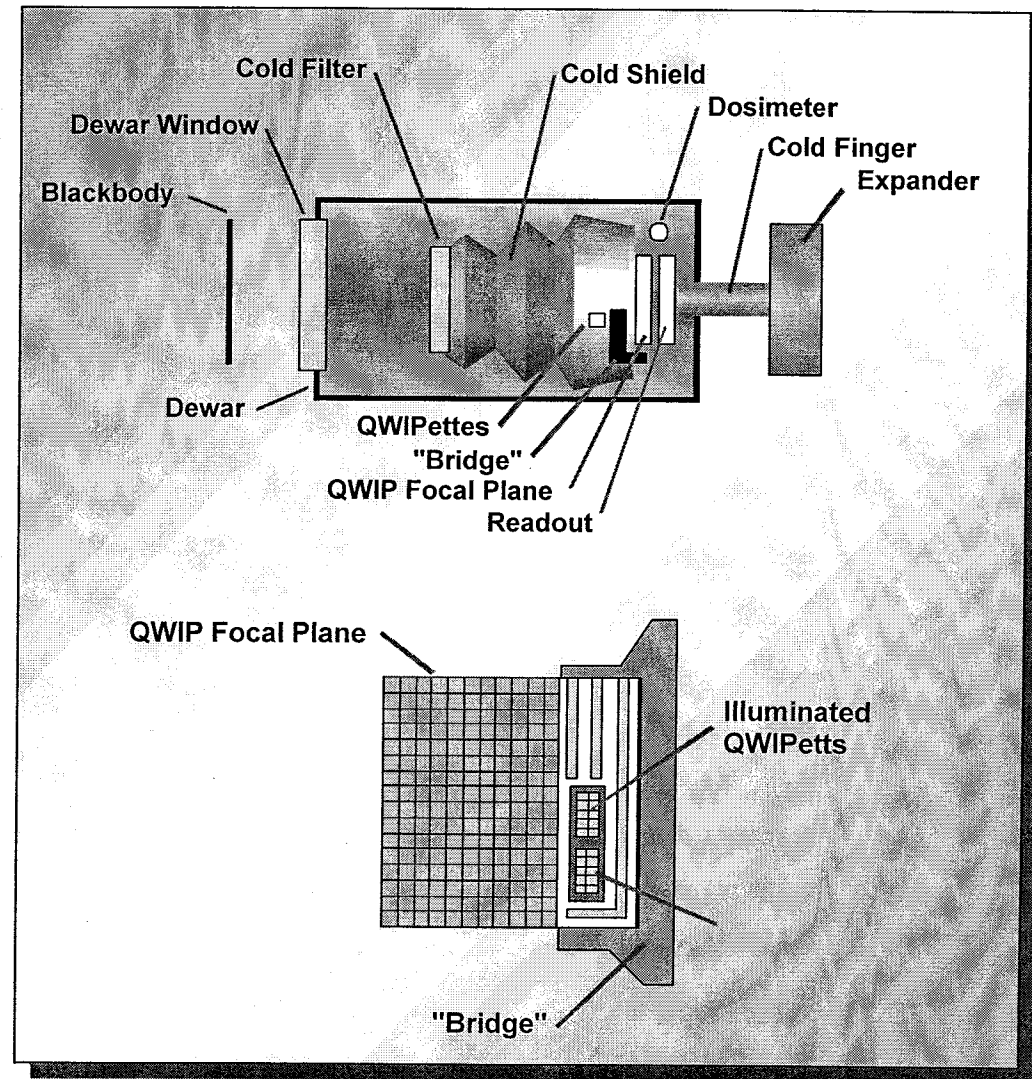


FPA AND QWIPettes

- Focal Plane Bridge
 - Masked Area *$1/3$ to $1/4$ of array*
 - Mount QWIPettes *over the FPA (consistent illumination)*
 - Thermal Interface *thermally integrated with motherboard*
- QWIPettes
 - Same detector material as FPA (wavelength, response, dark current, etc.)
 - A pair of 200 μm detectors illuminated (increases output signal)
 - Four 200 μm detectors coated with opaque material for dark current signal

DEWAR DESIGN

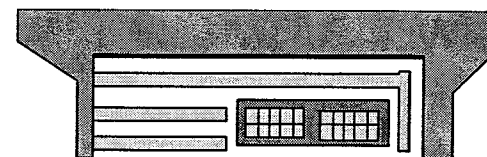
- QWIP Focal Plane Array is 128 x 128
 - 30 to 40 rows are shaded by the “bridge”
 - 5 to 10 rows are in “transition”, i.e. partially shaded
 - Remainder of focal plane is illuminated by the blackbody



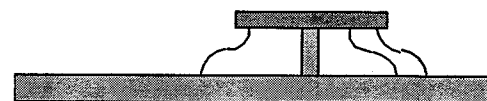
QWIPette DESIGN

- **QWIPette Objective:**
 - *Measure dark current and photo current with discrete readout circuits (much more radiation tolerant than ROIC)*
- **Dark Current Measurement**
 - *Four detectors are wired in parallel to increase signal to noise ratio, provide larger current into readout circuit*
 - *Dark detectors coated with opaque epoxy*
- **Photo Current Measurement**
 - *Two detectors are wired in parallel to increase signal to noise ratio, the two detectors have gratings most similar to QWIP arrays*
- **Temperature Uniformity**
 - *Design ensures both parts of the QWIPettes are at the same temperature*

Top View



Side View



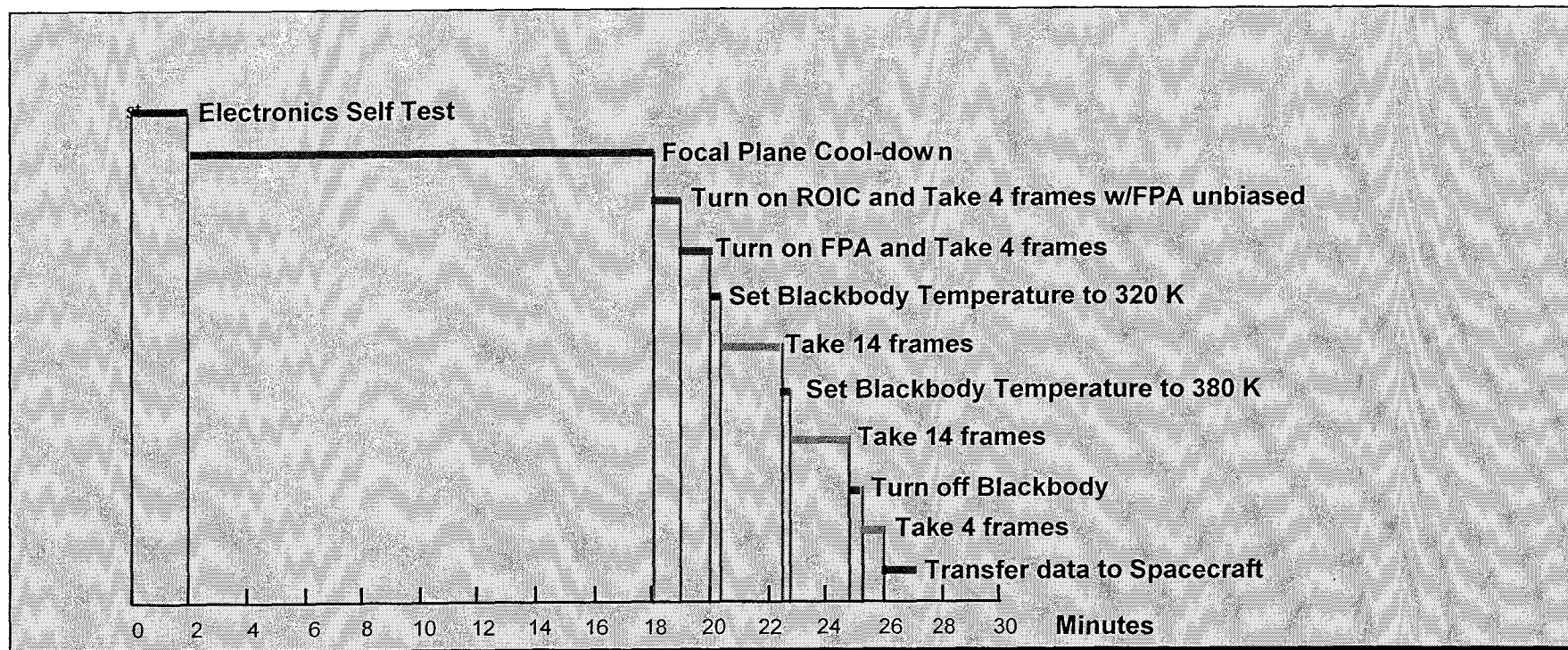


OPERATIONAL SCENARIO

- Data Collection Scenario
 - Collect 40 frames of Focal Plane Data
 - Collect 4 frames of data from the ROIC with FPA unbiased
 - Collect 4 frames of data from the FPA at 800 μ sec and 2 diode reads at 40Hz while viewing ambient conditions (Ambient frames).
 - Turn on blackbody (BB) to T1 (\sim 320K)
 - Collect 14 frames of data from the FPA at 800 μ sec and 16 diode reads at 40Hz while viewing the BB at T1 (Data frames).
 - Switch BB to T2 (\sim 380K).
 - Collect 14 frames of data from the FPA at 800 μ sec and 16 diode reads at 40Hz while viewing the BB at T2 only (Data frames).
 - Switch BB off.
 - Collect 4 frames of data from the FPA at 800 μ sec and 2 diode reads at 40Hz while viewing ambient conditions (Ambient frames).



OPERATION TIMELINE



The Experiment
operates every sixth
orbit (~ 2.6 days)

